20

60

80

100

Packaging Code

D

в

0.1

Insertion Loss (dB) 40

Insertion Loss Characteristics (Main Items)

NFM18CC221R10

Packaging

180mm Paper Tape

Bulk(Bag)

FM18CC101R1C

NFM18CC470U1C +NFM18

Frequency (MHz)

1000

100

6000

Minimum Quantity

4000

500

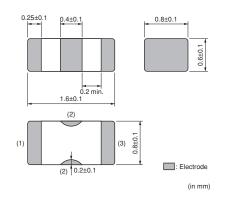
3B1C3 222R1C3

M18CC102R NFM18CC471R1C

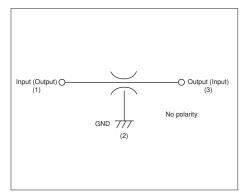
Data Sheet

EMIFIL[®] (Capacitor type) Single Circuit Type for Signal Lines NFM18C Series (0603 Size)

Dimensions



Equivalent Circuit



■ Rated Value (□: packaging code)

Part Number	Capacitance	Rated Current	Rated Voltage	Insulation Resistance (min.)	Operating Temperature Range
NFM18CC220U1C3	22pF ±20%	400mA	16Vdc	1000M ohm	-55 to +125°C
NFM18CC470U1C3	47pF ±20%	400mA	16Vdc	1000M ohm	-55 to +125°C
NFM18CC101R1C3	100pF ±20%	500mA	16Vdc	1000M ohm	-55 to +125°C
NFM18CC221R1C3	220pF ±20%	500mA	16Vdc	1000M ohm	-55 to +125°C
NFM18CC471R1C3	470pF ±20%	500mA	16Vdc	1000M ohm	-55 to +125°C
NFM18CC102R1C3	1000pF ±20%	600mA	16Vdc	1000M ohm	-55 to +125°C
NFM18CC222R1C3	2200pF ±20%	700mA	16Vdc	1000M ohm	-55 to +125°C
NFM18CC223R1C3	22000pF ±20%	1000mA	16Vdc	1000M ohm	-55 to +125°C

Number of Circuit: 1

Continued on the following page.

This data sheet is applied for CHIP EMIFIL® used for General Electronics equipment for your design.

/Note:

1. This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.

2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.



<u>mnRata</u> Murata Manufacturing Co., Ltd. http://www.murata.com/

Data Sheet

Continued from the preceding page.

■ ①Caution/Notice

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

2

This data sheet is applied for CHIP EMIFIL® used for General Electronics equipment for your design.

/Note:

1. This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.

2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

